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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# 200mW Surface Mount Schottky Barrier Diode

#### **FEATURES**

- Fast switching speed
- Low forward voltage drop
- Surface mount device type
- Moisture sensitivity level 1
- Matte Tin (Sn) lead finish with Nickel (Ni) underplate
- Pb free and RoHS compliant
- Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code





**SOT-363** 



#### **MECHANICAL DATA**

- Case: SOT-363 small outline plastic package
- Terminal: Matte tin plated, lead free, solderable per MIL-STD-202, Method 208 guaranteed

- High temperature soldering guaranteed: 260°C/10s

Polarity: Indicated by cathode bandWeight: 0.006 gram (approximately)Marking Code: KLA, KL6, KL7, KL8, KLB

PARAMETER	SYMBOL	VALUE	UNIT
Peak Repetitive Peak Reverse Voltage	V <sub>RRM</sub>		
Working Peak Reverse Voltage	$V_{RWM}$	30	V
DC Reverse Voltage	$V_{R}$		
Forward Continuous Current	I <sub>F</sub>	200	mA
Repetitive Peak Forward Current	I <sub>FRM</sub>	300	mA
Forward Surge Current @ t < 1.0 s	I <sub>FSM</sub>	600	mA
Power Dissipation	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient Air	$R_{\theta JA}$	625	°C/W
Operating and Storage temperature	T <sub>i</sub> , T <sub>STG</sub>	-55 to 125	°C

PAR	SYMBOL	MIN	MAX	UNIT	
Reverse Breakdown Voltage	I <sub>R</sub> =100μA	$V_{(BR)}$	30		V
	I <sub>F</sub> =1mA			0.32	
Farmer Vallage	I <sub>F</sub> =10mA	N/		0.40	.,
Forward Voltage	I <sub>F</sub> =30mA	$V_{F}$		0.50	V
	I <sub>F</sub> =100mA			1.00	
Reverse Current	V <sub>R</sub> =25V	I <sub>R</sub>		2.0	μA
Total Capacitance V <sub>R</sub> =1V, f=1.0MHz		$C_T$		10	pF
Reverse Recovery Time $I_F=I_R=10$ mA, $R_L=100\Omega$ , $I_R=100$ mA, $I_R=1000$ mA, $I_R=10000$ mA, $I_R=100000$ mA, $I_R=100000$ mA, $I_R=100000$ mA, $I_R=1000000$ mA, $I_R=10000000$ mA, $I_R=1000000000000000000000000000000000000$		t <sub>rr</sub>		5.0	nS

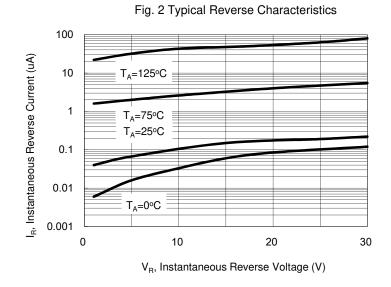
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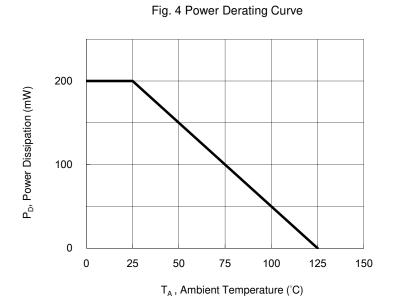


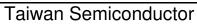
## **RATINGS AND CHARACTERISTICS CURVES**

(TA=25°C unless otherwise noted)

Fig. 1 Forward Characteristics (V) = (V) = (V) + (V)









ORDERING INFORMATION						
PART NO.	MANUFACTURE CODE	PACKING CODE	GREEN COMPOUND CODE	PACKAGE	PACKING	MARKING
BAT54T		RF	G	SOT-363	3K / 7" Reel	KLA
BAT54AD		RF	G	SOT-363	3K / 7" Reel	KL6
BAT54CD	(Note)	RF	G	SOT-363	3K / 7" Reel	KL7
BAT54SD		RF	G	SOT-363	3K / 7" Reel	KL8
BAT54BR		RF	G	SOT-363	3K / 7" Reel	KLB

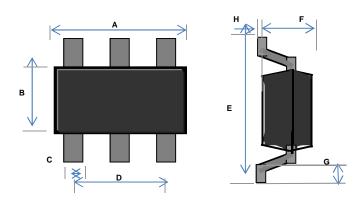
Note: Manufacture special control, if empty means no special control requirement.

EXAMPLE						
PREFERRED P/N	PREFERRED P/N PART NO. MANUFACTURE CODE PACKING CODE GREEN COMPOUND CODE			DESCRIPTION		
BAT54T RF	BAT54T		RF	G	Green compound	
BAT54T-D0 RF	BAT54T	D0	RF	G	Green compound	

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### **DIMENSIONS**

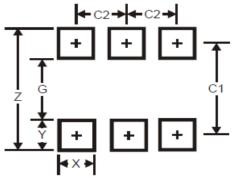


DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	2.000	2.200	0.079	0.087	
В	1.150	1.350	0.045	0.053	
С	0.150	0.350	0.006	0.014	
D	1.200	1.400	0.047	0.055	
Е	2.150	2.450	0.085	0.096	
F	0.850	1.050	0.033	0.041	
G	0.250	0.460	0.010	0.018	
Н	0.000	0.100	0.000	0.004	

Unit (mm)

Тур.

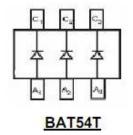
### SUGGESTED PAD LAYOUT

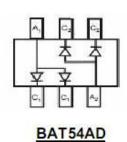


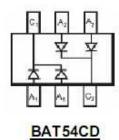
	Z	3.20	0.126
T 1	G	1.60	0.063
	Χ	0.55	0.022
<u>+</u>	Υ	0.80	0.031
<del></del>	C1	2.40	0.094
	C2	0.95	0.037
ANI			

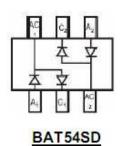
DIM

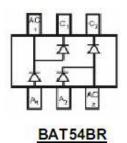
### **PIN CONFIGURATION**





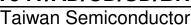






Unit (inch)

Тур.





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